



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

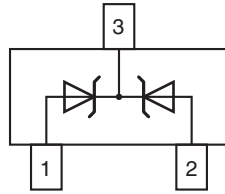
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



Small Signal Zener Diodes, Dual



FEATURES

- Dual silicon planar Zener diodes, common cathode
- The Zener voltages are graded according to the international E24 standard. Standard Zener voltage tolerance is $\pm 5\%$.
- The parameters are valid for both diodes in one case. ΔV_Z and ΔR_{zj} of the two diodes in one case is $\leq 5\%$
- AEC-Q101 qualified
- ESD capability according to AEC-Q101:
Human body model > 8 kV
Machine model > 800 V
- Base P/N-G3 - green, commercial grade
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



PRIMARY CHARACTERISTICS		
PARAMETER	VALUE	UNIT
V_Z range nom.	2.7 to 51	V
Test current I_{ZT}	5	mA
V_Z specification	Pulse current	
Int. construction	Dual common cathode	

ORDERING INFORMATION			
DEVICE NAME	ORDERING CODE	TAPED UNITS PER REEL	MINIMUM ORDER QUANTITY
DZ23-G-Series	DZ23C2V7-G3-08 to DZ23C51-G3-08	3000 (8 mm tape on 7" reel)	10 000
	DZ23C2V7-G3-18 to DZ23C51-G3-18	10 000 (8 mm tape on 13" reel)	15 000

PACKAGE				
PACKAGE NAME	WEIGHT	MOLDING COMPOUND FLAMMABILITY RATING	MOISTURE SENSITIVITY LEVEL	SOLDERING CONDITIONS
SOT-23	8.1 mg	UL 94 V-0	MSL level 1 (according J-STD-020)	260 °C/10 s at terminals

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ °C}$, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Power dissipation	Device on fiberglass substrate, see layout on page 6	P_{tot}	300	mW
Thermal resistance, junction to ambient air	Device on fiberglass substrate, see layout on page 6	R_{thJA}	420	K/W
Junction temperature		T_j	150	°C
Storage temperature range		T_{stg}	- 65 to + 150	°C
Operating temperature range		T_{op}	- 55 to + 150	°C
Zener current		I_Z	P_{tot}/V_Z	mA



ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)												
PART NUMBER	MARKING CODE	ZENER VOLTAGE RANGE ⁽¹⁾			TEST CURRENT		REVERSE VOLTAGE		DYNAMIC RESISTANCE $f = 1\text{ kHz}$		TEMPERATURE COEFFICIENT OF ZENER VOLTAGE	
		V_Z at I_{ZT1}			I_{ZT1}	I_{ZT2}	V_R at I_R		Z_Z at I_{ZT1}	Z_{ZK} at I_{ZT2}	α_{VZ} at I_{ZT1}	
		V			mA		V	nA	Ω		$10^{-4}/^{\circ}\text{C}$	
		MIN.	NOM.	MAX.			MAX.		MAX.	MAX.	MIN.	MAX.
DZ23C2V7-G	V41	2.5	2.7	2.9	5	1	-	-	75 (< 83)	< 500	- 9	- 4
DZ23C3V0-G	V42	2.8	3.0	3.2	5	1	-	-	80 (< 95)	< 500	- 9	- 3
DZ23C3V3-G	V43	3.1	3.3	3.5	5	1	-	-	80 (< 95)	< 500	- 8	- 3
DZ23C3V6-G	V44	3.4	3.6	3.8	5	1	-	-	80 (< 95)	< 500	- 8	- 3
DZ23C3V9-G	V45	3.7	3.9	4.1	5	1	-	-	80 (< 95)	< 500	- 7	- 3
DZ23C4V3-G	V46	4	4.3	4.6	5	1	-	-	80 (< 95)	< 500	- 6	- 1
DZ23C4V7-G	V47	4.4	4.7	5	5	1	-	-	70 (< 78)	< 500	- 5	2
DZ23C5V1-G	V48	4.8	5.1	5.4	5	1	> 0.8	100	30 (< 60)	< 480	- 3	4
DZ23C5V6-G	V49	5.2	5.6	6	5	1	> 1	100	10 (< 40)	< 400	- 2	6
DZ23C6V2-G	V50	5.8	6.2	6.6	5	1	> 2	100	4.8 (< 10)	< 200	- 1	7
DZ23C6V8-G	V51	6.4	6.8	7.2	5	1	> 3	100	4.5 (< 8)	< 150	2	7
DZ23C7V5-G	V52	7	7.5	7.9	5	1	> 5	100	4 (< 7)	< 50	3	7
DZ23C8V2-G	V53	7.7	8.2	8.7	5	1	> 6	100	4.5 (< 7)	< 50	4	7
DZ23C9V1-G	V54	8.5	9.1	9.6	5	1	> 7	100	4.8 (< 10)	< 50	5	8
DZ23C10-G	V55	9.4	10	10.6	5	1	> 7.5	100	5.2 (< 15)	< 70	5	8
DZ23C11-G	V56	10.4	11	11.6	5	1	> 8.5	100	6 (< 20)	< 70	5	9
DZ23C12-G	V57	11.4	12	12.7	5	1	> 9	100	7 (< 20)	< 90	6	9
DZ23C13-G	V58	12.4	13	14.1	5	1	> 10	100	9 (< 25)	< 110	7	9
DZ23C15-G	V59	13.8	15	15.6	5	1	> 11	100	11 (< 30)	< 110	7	9
DZ23C16-G	V60	15.3	16	17.1	5	1	> 12	100	13 (< 40)	< 170	8	9.5
DZ23C18-G	V61	16.8	18	19.1	5	1	> 14	100	18 (< 50)	< 170	8	9.5
DZ23C20-G	V62	18.8	20	21.2	5	1	> 15	100	20 (< 50)	< 220	8	10
DZ23C22-G	V63	20.8	22	23.3	5	1	> 17	100	25 (< 55)	< 220	8	10
DZ23C24-G	V64	22.8	24	25.6	5	1	> 18	100	28 (< 80)	< 220	8	10
DZ23C27-G	V65	25.1	27	28.9	5	1	> 20	100	30 (< 80)	< 250	8	10
DZ23C30-G	V66	28	30	32	5	1	> 22.5	100	35 (< 80)	< 250	8	10
DZ23C33-G	V67	31	33	35	5	1	> 25	100	40 (< 80)	< 250	8	10
DZ23C36-G	V68	34	36	38	5	1	> 27	100	40 (< 90)	< 250	8	10
DZ23C39-G	V69	37	39	41	5	1	> 29	100	50 (< 90)	< 300	10	12
DZ23C43-G	V70	40	43	46	5	1	> 32	100	60 (< 100)	< 700	10	12
DZ23C47-G	V71	44	47	50	5	1	> 35	100	70 (< 100)	< 750	10	12
DZ23C51-G	V72	48	51	54	5	1	> 38	100	70 (< 100)	< 750	10	12

Note

(1) Tested with pulses $t_p = 5\text{ ms}$

TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

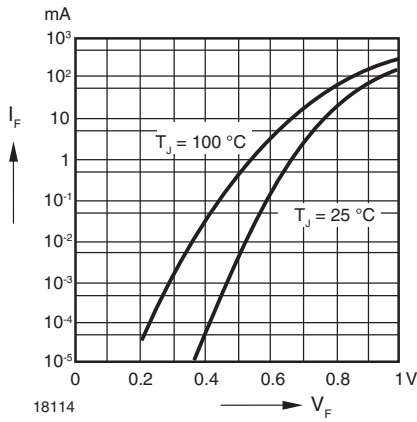


Fig. 1 - Forward Characteristics

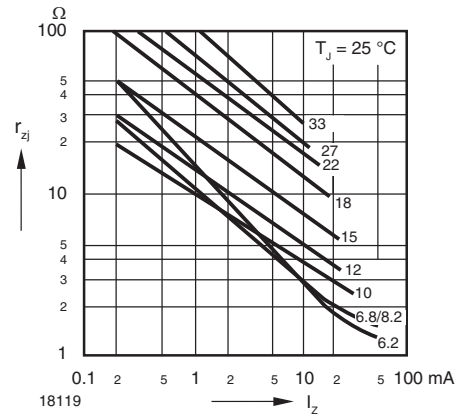


Fig. 4 - Dynamic Resistance vs. Zener Current

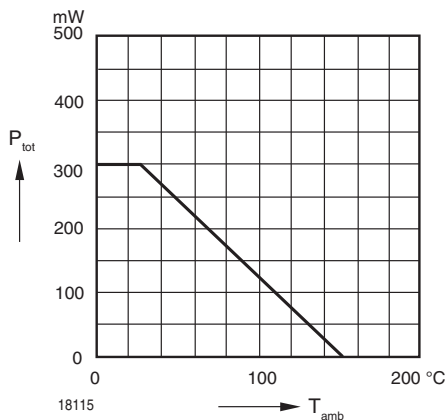


Fig. 2 - Admissible Power Dissipation vs. Ambient Temperature

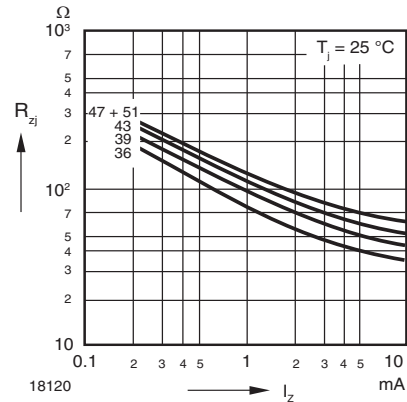


Fig. 5 - Dynamic Resistance vs. Zener Current

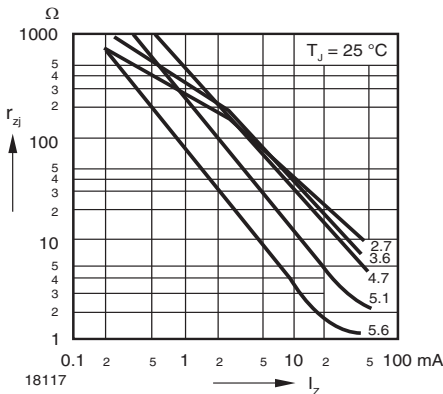


Fig. 3 - Dynamic Resistance vs. Zener Current

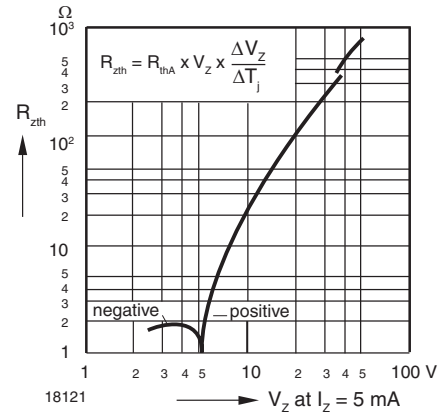


Fig. 6 - Thermal Differential Resistance vs. Zener Voltage

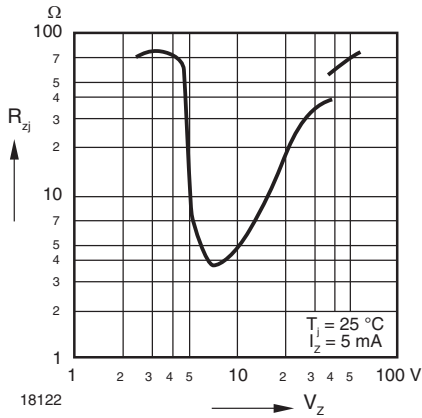


Fig. 7 - Dynamic Resistance vs. Zener Voltage

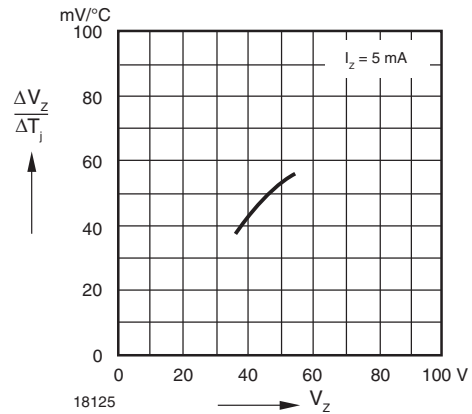


Fig. 10 - Temperature Dependence of Zener Voltage vs. Zener Voltage

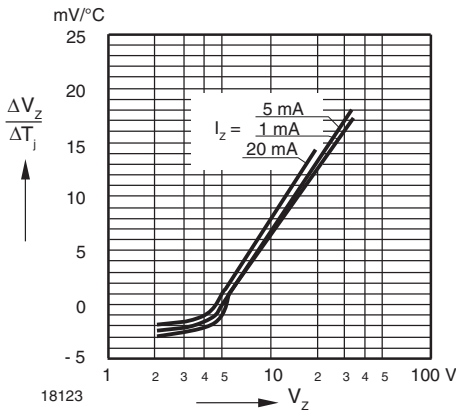


Fig. 8 - Temperature Dependence of Zener Voltage vs. Zener Voltage

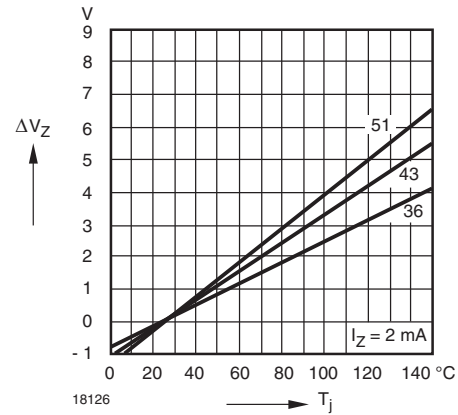


Fig. 11 - Change of Zener Voltage vs. Junction Temperature

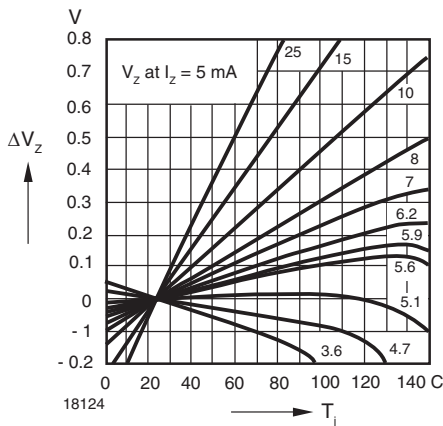


Fig. 9 - Change of Zener Voltage vs. Junction Temperature

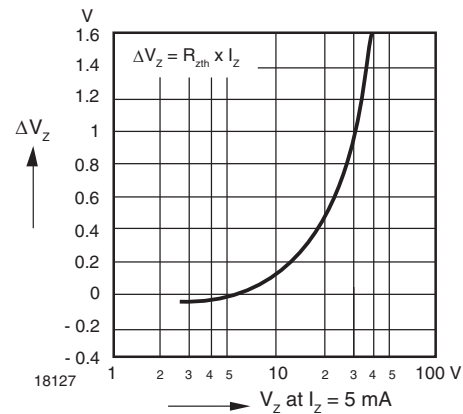


Fig. 12 - Change of Zener Voltage from Turn-on to the Point of Thermal Equilibrium vs. Zener voltage

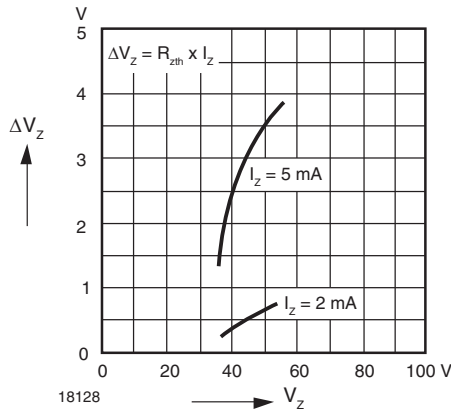


Fig. 13 - Change of Zener Voltage from Turn-on up to the Point of Thermal Equilibrium vs. Zener voltage

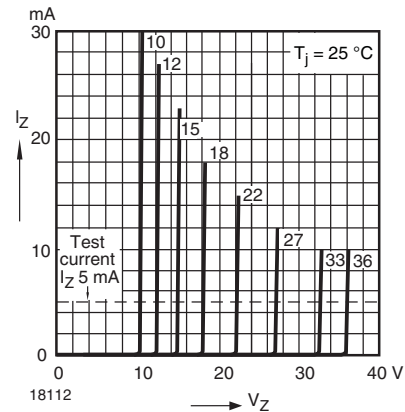


Fig. 15 - Breakdown Characteristics

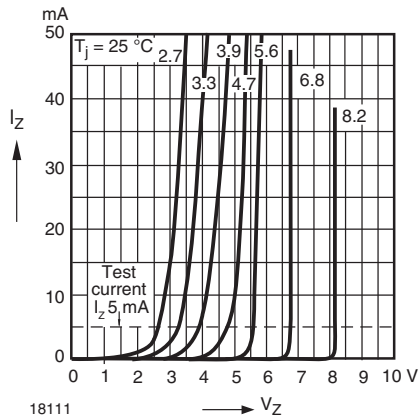


Fig. 14 - Breakdown Characteristics

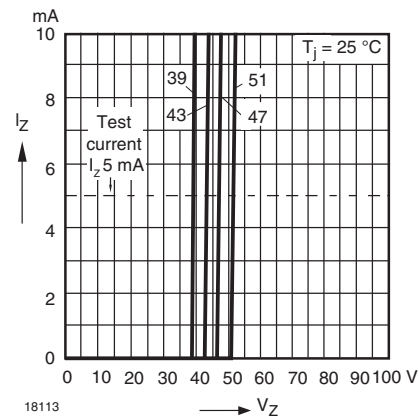
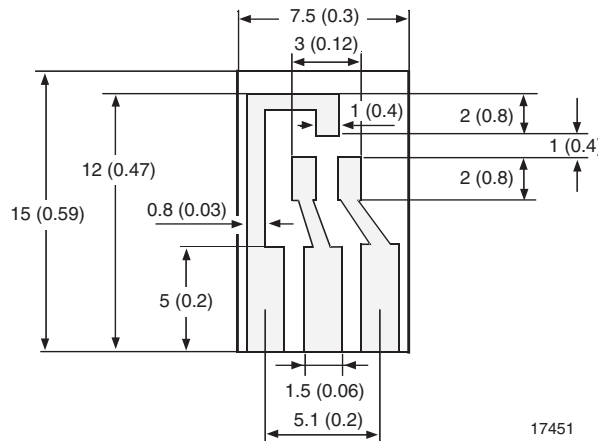


Fig. 16 - Breakdown Characteristics

LAYOUT FOR R_{thJA} TEST

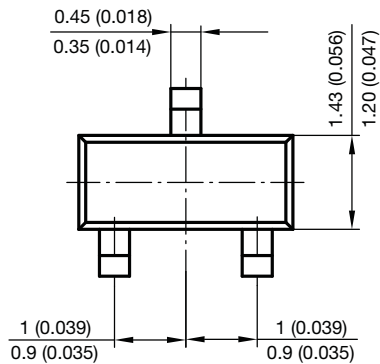
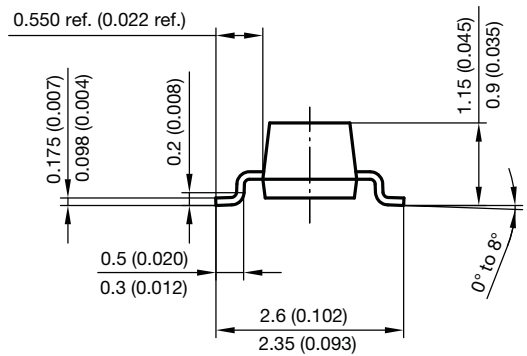
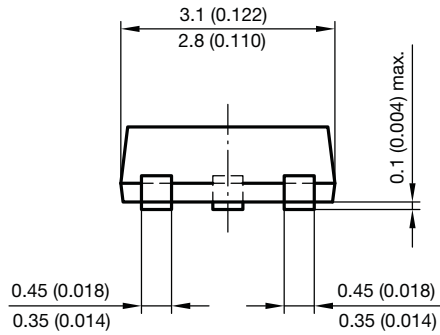
Thickness: fiberglass 0.059" (1.5 mm)
Copper leads 0.012" (0.3 mm)



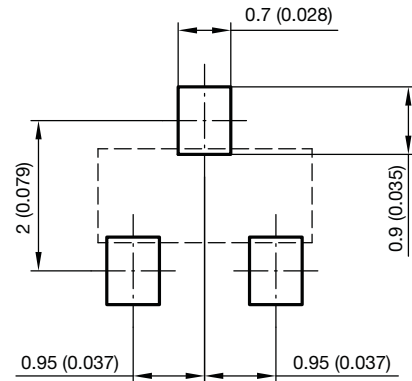
17451



PACKAGE DIMENSIONS in millimeters (inches): **SOT-23**



Foot print recommendation:



Document no.: 6.541-5014.01-4
Rev. 8 - Date: 23.Sept.2009
17418



Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.